



USB OTG 5V Charge Pump

General Description

The AAT3125 USB On-the-Go (OTG) charge pump is a member of Skyworks' Total Power Management ICTM (TPMICTM) product family. The device integrates a high efficiency 1.5X fractional 100mA regulated charge pump for supplying V_{BUS} with the additional functions required for OTG devices (formerly known as dual role devices). Four voltage detectors monitor V_{BUS}, and a current source dedicated for V_{BUS} pulsing is provided for compliance with Session Request Protocol (SRP) as defined by the USB OTG Supplement.

The charge pump section uses a high efficiency fractional topology, with a high frequency 750kHz switching speed which enables the use of small capacitors (less than 3.3μ F). The AAT3125 features extremely low quiescent current to extend battery run time. Additionally, the device integrates protection features such as undervoltage lockout, and output short circuit and thermal protection.

The AAT3125 is available in a Pb-free, surface mount QFN44-16 package and is rated over the -40°C to +85°C temperature range.

Features

- V_{IN} Range: 2.7V to 5.5V
- Regulated Fractional Charge Pump
- 100mA Output Current
- Reverse Load Protection
- Power Good Flag
- SRP Detection Flag
- SRP Ready Flag
- Output Short-Circuit and Thermal Protection
- Under-Voltage Protection
- Less than 1µA Consumed While Disabled
- Designed to Allow Operation with Output Capacitance as Low as $3.3 \mu\text{F}$
- 16-pin QFN44 Package
- -40°C to +85°C Temperature Range

Applications

- Cell Phones
- Hand-Held Computers
- PDAs



Typical Application



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Pin Descriptions

Pin #	Symbol	Function			
1	POK1	Power OK 1. Open drain output with 4.0V voltage detector. When the OUT pin rises above the detected voltage (4.0V), POK1 will transition from low to high state. Similarly, when the output falls below 4.0V, POK1 will transition from high to low. A $10k\Omega$ pull-up resistor is recommended.			
2	POK2	Power OK 2. Open drain output with 4.4V voltage detector. When the OUT pin rises above the detected voltage (4.4V), POK2 will transition from low to high state. Similarly, when the output falls below 4.4V, POK2 will transition from high to low. A $10k\Omega$ pull-up resistor is recommended.			
3	SESDET	Session detect. Open drain output with 2.0V voltage detector. When the OUT pin rises above the detected voltage (2.0V), it will transition from low to high state. Similarly, when the output falls below 2.0V, SES-DET will transition from high to low. A $10k\Omega$ pull-up resistor is recommended.			
4	SRRDY	Session request ready. Open drain output with 0.6V voltage detector. When the OUT pin rises above the detected voltage (0.6V), it will transition from low to high state. Similarly, when the output falls below 0.6V, SRRDY will transition from high to low. A $10k\Omega$ pull-up resistor is recommended.			
5	OUT	Power output to VBUS.			
6	C1+	Flying capacitor 1 positive terminal.			
7	C1-	Flying capacitor 1 negative terminal.			
8, 13	N/C	No connect.			
9	OUTCP	Charge pump output. Requires 1µF bypass capacitor to ground.			
10	C2+	Flying capacitor 2 positive terminal.			
11	C2-	Flying capacitor 2 negative terminal.			
12	GND	Ground.			
14	VIN	Input power supply. Requires 1µF bypass capacitor to ground.			
15	SR	Session request input control pin. Should not be left floating. Must connect to high or low. For more de- tails, see Table 1.			
16	EN	Enable input control pin. When in the low state, the AAT3125 is powered down and consumes a small amount of power. When connected high, it is in normal operation. This pin should not be left floating. For more details, see Table 1.			
EP		Exposed paddle (bottom); connect to GND directly beneath package.			

Pin Configuration

QFN44-16 (Top View)



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Absolute Maximum Ratings¹

Symbol	Description	Value	Units
V _{IN} , V _{OUT}	Any Pin to GND	-0.3 to 6	V
t _{sc}	OUT Short-Circuit Duration	Indefinite	S
I _{OUT} ²	Output Current	150	mA
T ₁	Operating Temperature Range	-40 to 85	°C
Ts	Storage Temperature Range	-65 to 150	°C
V _{ESD}	ESD Rating ³ - HBM	2000	V

Thermal Information

Symbol	Description	Value	Units
θ _{JA}	Maximum Thermal Resistance ⁴	50	°C/W
PD	Maximum Power Dissipation $(T_A = 25^{\circ}C)^{5}$	2.0	W

^{1.} Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation at conditions other than the operating conditions specified is not implied. Only one Absolute Maximum Rating should be applied at any one time. 2. Based on long-term current density limitation.

^{3.} Human body model is a 100pF capacitor discharged through a $1.5k\Omega$ resistor into each pin.

^{4.} Mounted on an FR4 board.

^{5.} Derate 20mW/°C above 25°C.



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Electrical Characteristics¹

 $V_{IN} = 3.5V$; $C_{IN} = C_{OUT} = C_1 = C_2 = 1.0 \mu$ F; $T_A = -40^{\circ}$ C to $+85^{\circ}$ C. Unless otherwise noted, typical values are $T_A = 25^{\circ}$ C.

Symbol	Description	Conditions	Min	Тур	Max	Units	
Input Power Su	Input Power Supply						
	V _{IN} Operating Range		2.9		5.5	V	
I _{cc3}	Operating Current SRP	EN = 1, SR = 1, OUT = IN		60	110	μA	
I _{cc2}	Operating Current CP	EN = 1, SR = 0		1	3	mA	
I _{cc1}	Shutdown Current 1	EN = 0, SR = 1		1	2	μA	
I _{cc0}	Shutdown Current 0	EN = 0, SR = 0			1	μA	
Output Power S	upply						
V _{out}	Output Regulation	$I_{OUT} = 0$	4.6		5.25	V	
I _{CCOUT}	Operating Current	EN = 0		7	12	μA	
I _{OUT}	Output Current	$3.2 \le V_{IN} \le 5.5V, V_{OUT} > 4.4V$	50	65		mA	
		$3.35 \le V_{IN} \le 5.5V, V_{OUT} > 4.4V$		100			
V _{cs}	Current Sense Trip Level	$VCS = I_{OUT} \times R_{CS}$	40	60	90	mV	
R _{OFF}	Pull-Down Resistance	EN = 0, SR = 1	700	1000	1500	Ω	
I _{SR}	SR Current Pulse	OUT < (IN-1.0v)	5	10	20	mA	
Charge Pump							
η	Efficiency	$V_{IN} = 3.75V, I_{OUT} = 50mA$		90		%	
T _{ss}	Soft-Start Time	OUT < 0.1 to OUT > 4.4		100		μs	
F _{CLK}	Clock Frequency			750		kHz	
EN, SR							
V _{IL}	Input Threshold Low				0.4	V	
V _{IH}	Input Threshold High		1.4			V	
I _{EN(SINK)}	EN Input Current	$V_{IN} = V_{EN} = 5.5V$	-1		1	μA	
I _{SR(SINK)}	SR Input Current	$V_{IN} = V_{SR} = 5.5V$	-1		1	μA	
POK1							
V _{POK1}	POK Trip Threshold	V _{out} Rising	3.8	4.0	4.2	V	
V _{POK1(HYS)}	POK Hysteresis			50		mV	
V _{POK1(OL)}	POK Output Voltage	$I_{SINK} = 1mA$			0.3	V	
I _{POK1}	POK Leakage Current	V _{POK} = 5.5V, 25°C			100	nA	
POK2							
V _{POK2}	POK Trip Threshold	V _{out} Rising	4.18	4.4	4.62	V	
V _{POK2(HYS)}	POK Hysteresis			50		mV	
V _{POK2(OL)}	POK Output Voltage	$I_{SINK} = 1 mA$			0.3	V	
I _{POK2}	POK Leakage Current	V _{POK} = 5.5V, 25°C			100	nA	
SESDET							
V _{SD}	SD Trip Threshold	V _{out} Rising	1.9	2.0	2.1	V	
V _{SD(HYS)}	SD Hysteresis			50		mV	
V _{SD(OL)}	SD Output Voltage	$I_{SINK} = 1 mA$			0.3	V	
I _{SD}	SD Leakage Current	V _{SD} = 5.5V, 25°C			100	nA	
SRRDY							
V _{SRRDY}	SRRDY Trip Threshold	V _{OUT} Rising	0.4	0.6	0.8	V	
V _{SRRDY(HYS)}	SRRDY Hysteresis			20		mV	
V _{SRRDY(OL)}	SRRDY Output Voltage	I _{SINK} = 1mA			0.3	V	
I _{SRRDY}	SRRDY Leakage Current	$V_{SRRDY} = 5.5V, 25^{\circ}C$			100	nA	

 The AAT3125 is guaranteed to meet performance specifications over the -40°C to +85°C operating temperature range and is assured by design, characterization, and correlation with statistical process controls.



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EN	SR	Charge Pump	Current Source	SRRDY	POK	SESDET	Discharge Resistor
1	0	ON	OFF	ON	ON	ON	OFF
1	1	OFF	ON	ON	ON	ON	OFF
0	0	OFF	OFF	OFF	OFF	ON	OFF
0	1	OFF	OFF	OFF	OFF	ON	ON

Table 1: Operational States.

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Typical Characteristics

Unless otherwise noted, V_{IN} = 3.5V, C_{IN} = C_{OUT} = C_1 = C_2 = 1µF, T_A = 25°C.

OUT (1V/div) IIN (100mA/div) EN (1V/div)

Time (2ms/div)

Charge Pump Waveforms (100mA load)



Time (1µs/div)

Charge Pump Output Voltage



Charge Pump ON/OFF Timing



Efficiency vs. Load Current

Load Transient Response (10mA to 100mA)



Time (4ms/div)

Charge Pump Output Voltage vs. Input Voltage (I_{LOAD} = 100mA)



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Typical Characteristics

Unless otherwise noted, $V_{IN} = 3.5V$, $C_{IN} = C_{OUT} = C_1 = C_2 = 1\mu$ F, $T_A = 25^{\circ}$ C.



Shutdown Current vs. Input Voltage (EN = 0; SR = 1)







I_{ccout} vs. V_{out}



Charge Pump POK Timing



Time (100µs/div)

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Typical Characteristics

Unless otherwise noted, V_{IN} = 3.5V, C_{IN} = C_{OUT} = C_1 = C_2 = 1µF, T_A = 25°C.

Falling SESDET Timing



Time (100ms/div)

V_{BUS} Pulsing for SRP (V_{BUS} Rise Time; 5µF on V_{BUS})



Rising SESDET, SRRDY Timing (120µF Load)



Time (10ms/div)

V_{BUS} Pulsing for SRP (V_{BUS} Rise Time; 100µF on V_{BUS})



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Functional Block Diagram



Functional Description

Charge Pump

The AAT3125 charge pump uses a 1.5X topology; the two flying capacitors are charged in series and discharged in parallel. Using this topology, output current is approximately 2/3 input current. Since the power bus in battery-operated devices that use a single cell lithium-ion/polymer battery ranges from 3V to 4.5V, an output voltage above 4.4V can be maintained. Output voltage is regulated to 5V and output current is limited by the value of R_{cs} . The charge pump is designed to operate safely with any combination of input and output voltage es. Current is not allowed to flow from OUT to IN.

10mA Current Source

A 10mA current source supplies current to OUT for V_{BUS} pulsing during SRP. During V_{BUS} pulsing, the length of time needed to charge capacitance connected to OUT distinguishes between non-SRP capable devices and SRP capable devices. Using 10mA, SESDET should rise about 7ms after SRRDY rises when an OTG device is connected. With a non-OTG device connected, this period is at

least 70ms. 10mA should not damage non-SRP capable hosts that allow reverse current flow from the bus. Current is not allowed to flow from OUT to IN through the current source.

SESDET MicroPower Voltage Detector

The SESDET open drain output signals the use of SRP while the system is acting as the A device. OUT powers this detector because the local 5V bus may not be powered when the B device initiates SRP. Since V_{BUS} provides no more than 150µA to OUT, the detector consumes only 7µA.

SRRDY Voltage Detector

The SRRDY open drain output signals that V_{BUS} is ready for SRP. SRRDY is powered by IN and is active as long as IN is above the UVLO level. SRRDY is true (low) when OUT is below the SRRDY threshold (0.6V nominal). SRRDY is false (open) when OUT is above the SRRDY threshold or when EN is a logic low. Upon activation by EN, there is no negative glitch that can be mistaken for OUT below 0.8V.

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Power OK

USB OTG devices connected as Host must maintain V_{OUT} above 4.4 volts or report that it is below 4.4 volts. Two Power OK outputs (POK1 and POK2) provide a window comparison of the V_{OUT} voltage. The POK1 open drain output is pulled low if V_{OUT} drops below 4.0V \pm 5%, and the POK2 open drain output is pulled low if V_{OUT} drops below 4.4V \pm 5%.

Under-Voltage Lockout

Circuits other than the MicroPower voltage detector (SESDET) require voltage to be present on IN. Undervoltage lockout guarantees that sufficient voltage is present on IN to ensure operation. All functions other than the SESDET flag are disabled if the voltage on IN is less than 2V.

Discharge Resistor

In accordance with the USB OTG specification, a pull-down resistor is provided to discharge $V_{\mbox{\tiny BUS}}$ at a current of not more than 8mA.

Over-Temperature Protection

If the AAT3125 junction temperature exceeds 125°C, the charge pump is shut down.



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Ordering Information

Package	Marking ¹	Part Number (Tape and Reel) ²
QFN44-16	ITXYY	AAT3125ISN-T1



Skyworks Green[™] products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*[™], document number SQ04-0074.

Package Information

QFN44-16³



All dimensions in millimeters

1. XYY = assembly and date code.

- 2. Sample stock is generally held on part numbers listed in BOLD.
- 3. The leadless package family, which includes QFN, TQFN, DFN, TDFN and STDFN, has exposed copper (unplated) at the end of the lead terminals due to the manufacturing process. A solder fillet at the exposed copper edge cannot be guaranteed and is not required to ensure a proper bottom solder connection.

025±0.025

900±0.

0.214 ± 0.036

Side View

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